

Amendments to the Specification:

Please replace the paragraph beginning at page 6, line 17 with the following amended paragraph:

Furthermore, it is possible to form an encapsulation over an OLED device that is built up on a barrier arrangement. Encapsulation can include forming a ~~fourth~~ third ceramic barrier layer over the second electrically conductive layer of the OLED device. The surface of the ~~fourth~~ third barrier layer is subsequently modified to introduce new nucleation sites on the surface. Afterwards, a ~~fifth~~ fourth ceramic barrier layer is formed on the ~~fourth~~ third ceramic barrier layer. A similar encapsulation method can be use with other electrical devices.